



DESD3V3S1BLP3

LOW CAPACITANCE BIDIRECTIONAL TVS DIODE

Features

- Ultra-Small, Low Profile Leadless Surface Mount Package (0.6 x 0.3 x 0.3mm)
- Provides ESD Protection per IEC 61000-4-2 Standard: Air – ±30kV, Contact – ±25kV
- 1 Channel of ESD Protection
- Low Channel Input Capacitance
- Typically Used in Cellular Handsets, Portable Electronics, Communication Systems, Computers and Peripherals
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: X3-DFN0603-2
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.0002 grams (Approximate)

X3-DFN0603-2







Top View

Bottom View

Device Schematic

Ordering Information (Note 4)

Product	Compliance	Marking	Reel Size(inches)	Tape Width(mm)	Quantity per Reel
DESD3V3S1BLP3-7	Standard	S	7	8	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

X3-DFN0603-2

S

S = Product Type Marking Code

Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Power Dissipation	P_PP	35	W	8/20µs, Per Fig. 3
Peak Pulse Current	I _{PP}	5	Α	8/20µs, Per Fig. 3
ESD Protection – Contact Discharge	$V_{ESD_Contact}$	±25	kV	IEC 61000-4-2 Standard
ESD Protection – Air Discharge	V_{ESD_Air}	±30	kV	IEC 61000-4-2 Standard



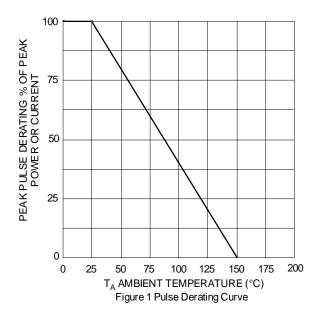
Thermal Characteristics

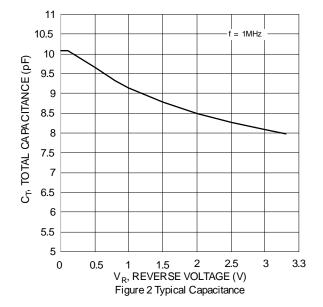
Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	P_{D}	250	mW
Thermal Resistance, Junction to Ambient (Note 5)	$R_{ heta JA}$	500	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

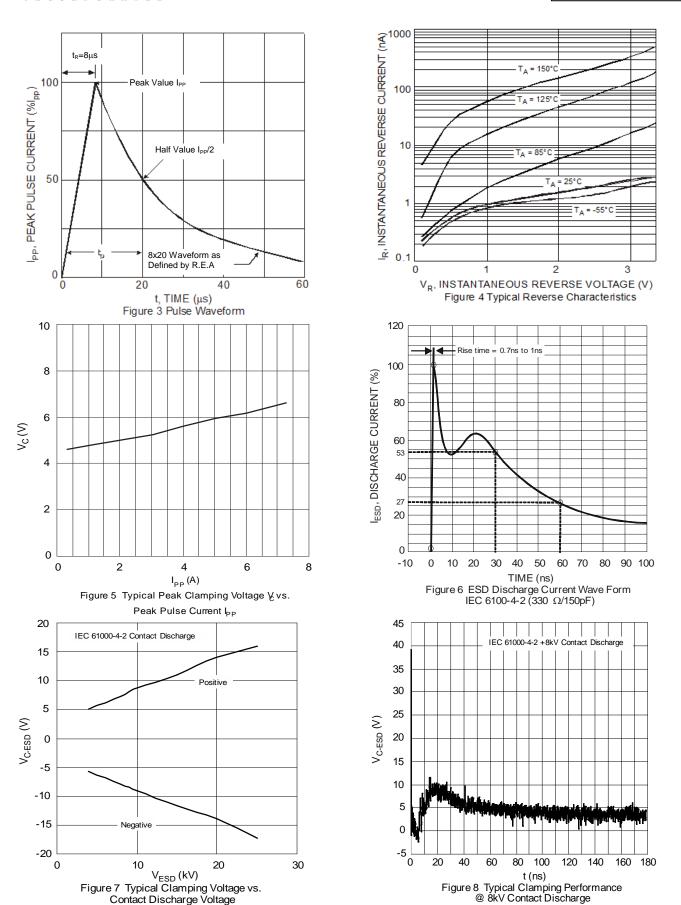
Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Standoff Voltage	V_{RWM}	_	_	3.3	V	_
Channel Leakage Current (Note 6)	I _{RM}	_	10	100	nA	$V_{RWM} = 3.3V$
Clamping Voltage, Positive Transients	V _{CL}	_	4.5	5.4	V	$I_{PP} = 1A$, $t_P = 8/20 \mu s$
Clamping voltage, Positive Transients		_	5.8	7.0		$I_{PP} = 5A$, $t_P = 8/20 \mu s$
Breakdown Voltage	V_{BR}	3.8	_	6.5	V	$I_R = 1mA$
Differential Resistance	R _{DIF}	_	0.3	_	Ω	I _R = 1A
Channel Input Capacitance	C _T	_	10	13	pF	$V_R = 0V$, $f = 1MHz$

Notes: 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes Incorporated's suggested pad layout, which can be found on our website http://www.diodes.com/package-outlines.html.
6. Short duration pulse test used to minimize self-heating effect.

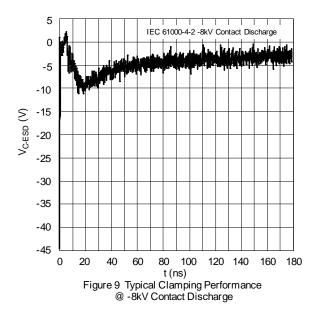


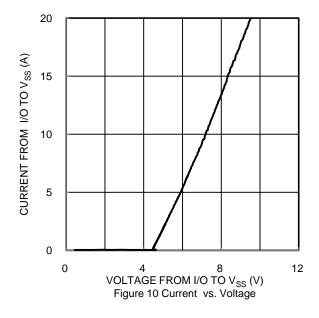








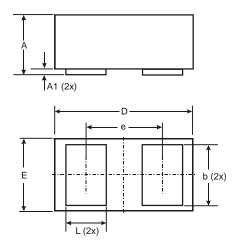




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

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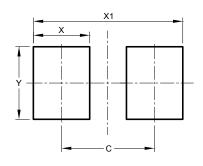


X3-DFN0603-2						
Dim	Min	Max	Тур			
Α	0.27	0.35	0.30			
A1	0.00	0.03	0.02			
b	0.19	0.29	0.24			
D	0.595	0.645	0.62			
Е	0.295	0.345	0.32			
е	-	-	0.355			
L	0.14	0.24	0.19			
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

X3-DFN0603-2



Dimensions	Value		
Dimensions	(in mm)		
С	0.380		
Х	0.230		
X1	0.610		
Υ	0.300		



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